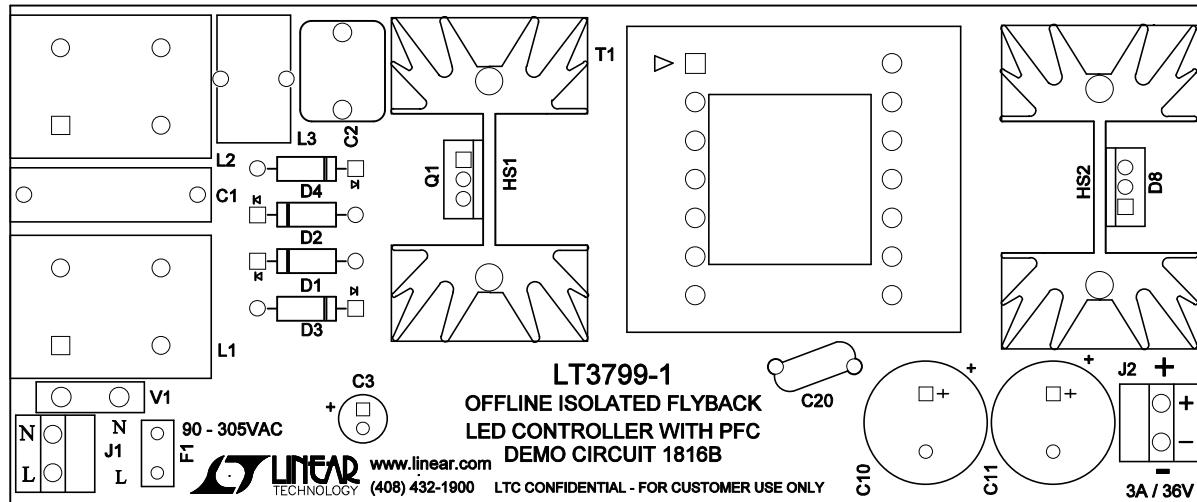


NOTES: UNLESS OTHERWISE SPECIFIED,

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER
SMD. MAXIMUM SOLDER TEMPERATURE, 240 DEG. C.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
5. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.



APPROVALS		TITLE: TOP ASSEMBLY DRAWING, OFFLINE ISOLATED FLYBACK LED CONTROLLER WITH PFC	
PCB DES.	MI	IC NO.	REV
APP. ENG.	GEORGE Q.	LT3799EMSE-1	1
		PCB NO. DEMO CIRCUIT 1816B	
SCALE: NONE	FILENAME: 1816B-Rev1.PCB	SHT 1 of 2	